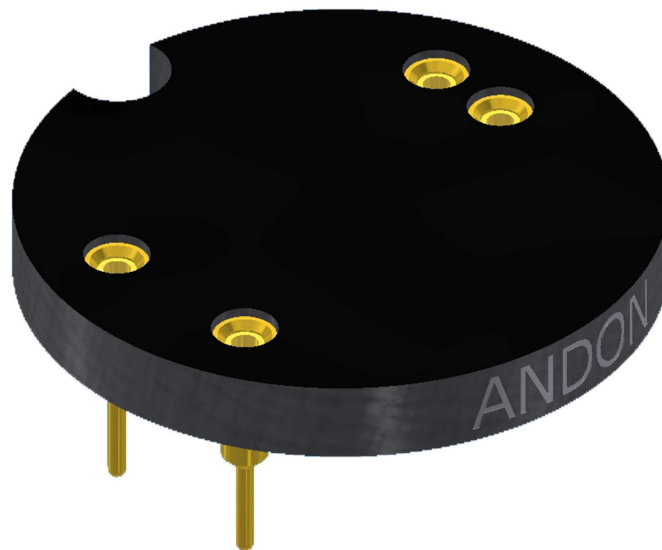




**HIGH RELIABILITY  
OPTOELECTRONIC SOCKETS FOR  
SST SENSING LTD.**

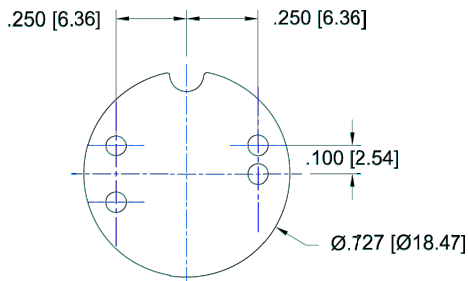


DESIGN • MANUFACTURE • CUSTOMISE • CONFIGURE

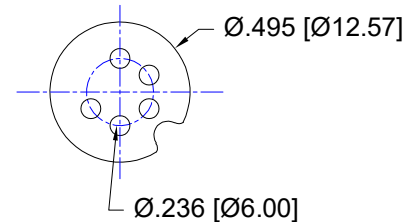


**Featuring Andon's Unique Senstac<sup>TM</sup> Contact**

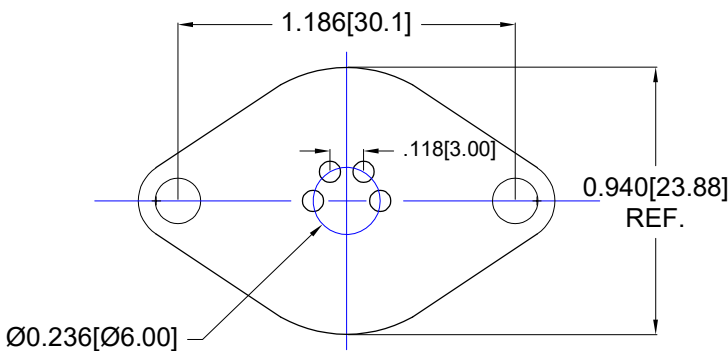
SST SENSING LTD.						
Model Number	Andon Part Number Replace "XXX" with Terminal Type	Terminal Type		Pin Ø [in]	Figure Number	Page Number
		Thru-Hole	Surface Mount			
O2S-FR-T3	R236-0605-01N-XXX-R27-L14	01P28	93P28	.028	2	1
CozIR®-A-Cased	409-205-XXX-R27-L14	01P28	93P28	0.025	6	2
CozIR®-LP2	417-208D-012-XXX-R27-L14	274UM	281UM	0.025	7	2
ExplorIR®-M	R472-SP04-01N-XXX-R27-L14	75S	384S	.020	5	2
LOX-01	R500-SP04-01N-XXX-R27-L14	01P28	93P28	.028	1	1
LOX-02	R500-SP04-01N-XXX-R27-L14	01P28	93P28	.028	1	1
LOX-02-F	R500-SP04-01N-XXX-R27-L14	01P28	93P28	.028	1	1
LOX-02-S	R500-SP04-01N-XXX-R27-L14	01P28	93P28	.028	1	1
O2S-FR-T4-4P	F236-SP04-01-01P28-R27-L14	01P28	93P28	.028	3	1
O2S-FR-T4-5P	F236-SP05-01-01P28-R27-L14	01P28	93P28	.028	4	1
O2S-T3	R236-0605-01N-XXX-R27-L14	01P28	93P28	.028	2	1
SP-A0-010	R200-0404-02T-XXX-R27-L14	01S	93S	.018	8	2
SP-A0-020	R200-0404-02T-XXX-R27-L14	01S	93S	.018	8	2
SP-A0-050	R200-0404-02T-XXX-R27-L14	01S	93S	.018	8	2
SP-A0-250	R200-0404-02T-XXX-R27-L14	01S	93S	.018	8	2
SP-A0-960	R200-0404-02T-XXX-R27-L14	01S	93S	.018	8	2
SprintIR®-6S	R472-SP04-01N-XXX-R27-L14	75S	384S	.020	5	2



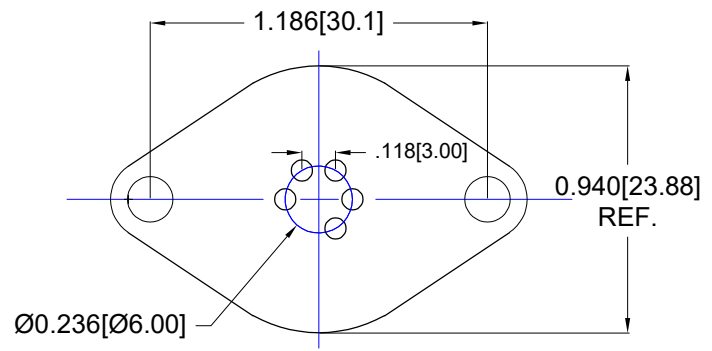
**FIG. 1**  
**Thru-Hole:** R500-SP04-01N-01P28-R27-L14  
**Surface Mount:** R500-SP04-01N-93P28-R27-L14



**FIG. 2**  
**Thru-Hole:** R236-0605-01N-01P28-R27-L14  
**Surface Mount:** R236-0605-01N-93P28-R27-L14



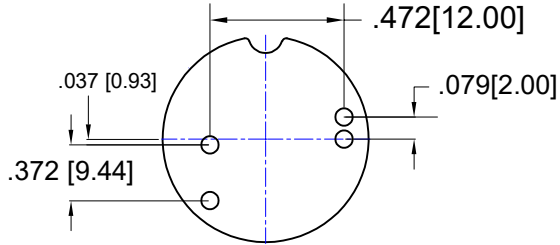
**FIG. 3**  
**Thru-Hole:** F236-SP04-01-01P28-R27-L14  
**Surface Mount:** F236-SP04-01-93P28-R27-L14



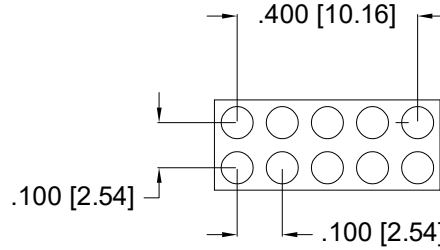
**FIG. 4**  
**Thru-Hole:** F236-SP05-01-01P28-R27-L14  
**Surface Mount:** F236-SP05-01-93P28-R27-L14

See last page for other mounting types including low profile options.  
 Heat sink socket available to reduce heat and noise. Contact Andon for details.

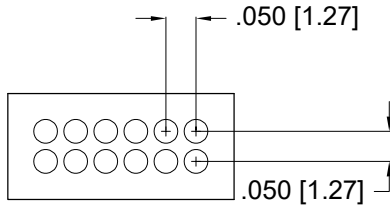
Units: in [mm]



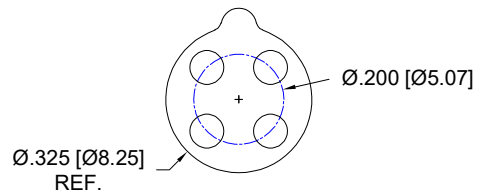
**FIG. 5**  
**Thru-Hole:** R472-SP04-01N-75S-R27-L14  
**Surface Mount:** R472-SP04-01N-384S-R27-L14



**FIG. 6**  
**Thru-Hole:** 409-205-01P28-R27-L14  
**Surface Mount:** 409-205-93P28-R27-L14



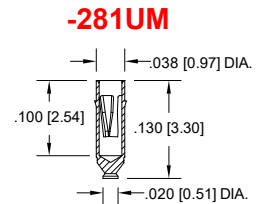
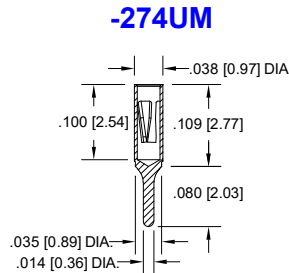
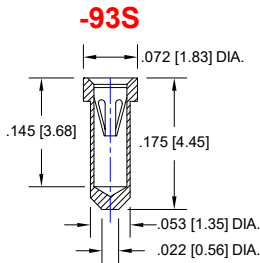
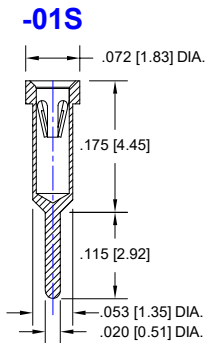
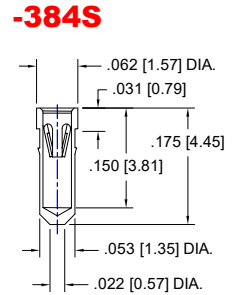
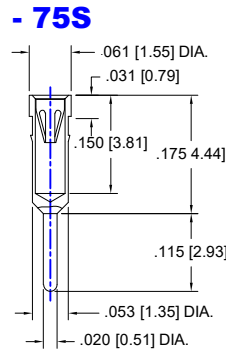
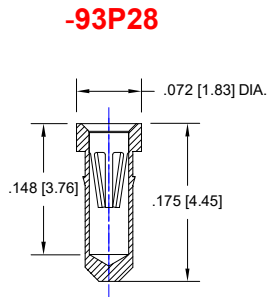
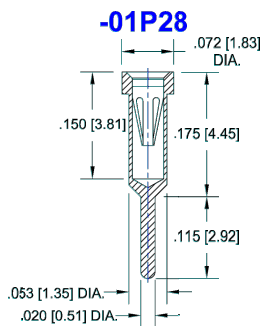
**FIG. 7**  
**Thru-Hole:** 417-208D-012-274U-R27-L14  
**Surface Mount:** 417-208D-012-281UM-R27-L14



**Fig. 8**  
**Thru-Hole:** R200-0404-02T-01S-R27-L14  
**Surface Mount:** R200-0404-02T-93S-R27-L14

See last page for other mounting types including low profile options.  
 Heat sink socket available to reduce heat and noise. Contact Andon for details.

Units: in [mm]



## Technical Information

### Material:

Insulator: Hi-Temp UL 94V-0  
Terminal: Brass, per ASTM-B16  
Contact: BeCu, Per ASTM-B194

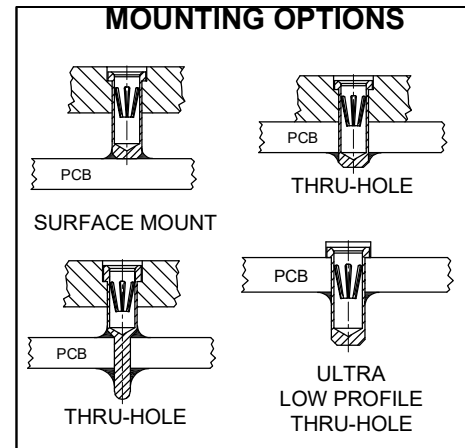
**Plating: RoHS COMPLIANT**

**R27 TERMINAL: GOLD / CONTACT: GOLD**  
**OTHER PLATINGS AVAILABLE**

### Terminal Acceptance and Forces

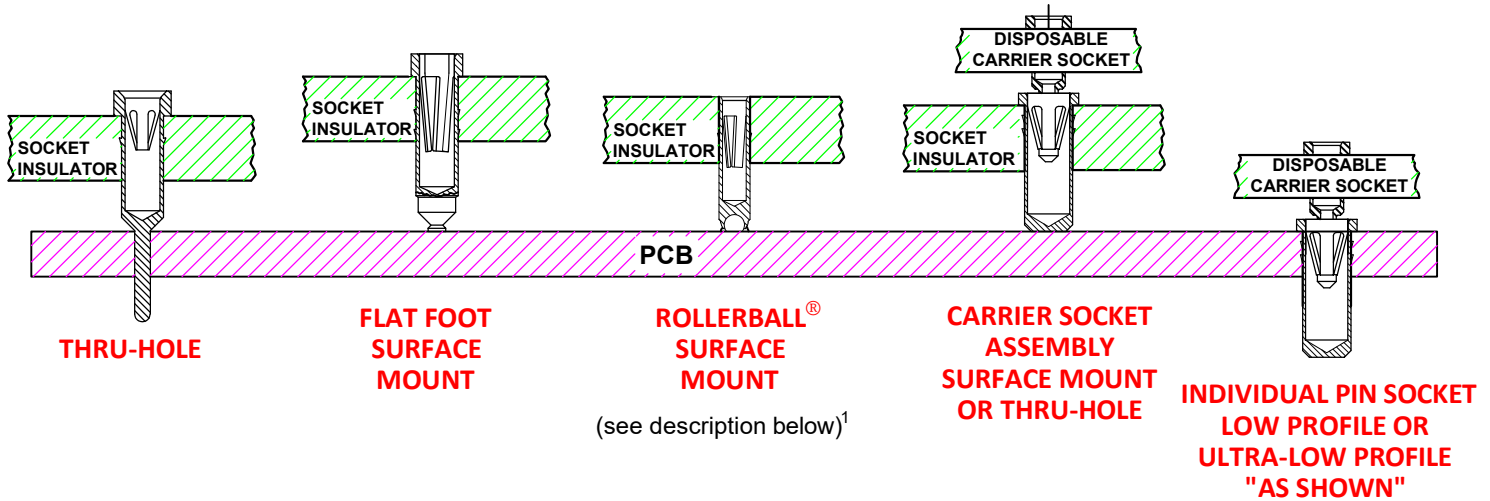
Thru Hole Terminals				Surface Mount Terminals			
Thru Hole Terminal	Accepts Pin Diameter	Insertion Force	Withdrawal Force	Surface Mount Terminal	Accepts Pin Diameter	Insertion Force	Withdrawal Force
-01P28	Ø.028 [Ø.71]	0.70 oz Avg.	0.35 oz Min	-93P28	Ø.028 [Ø.71]	0.70 oz Avg.	0.35 oz Min
-75S	Ø.018 [Ø.38]	9.0 oz Avg.	2.0 oz Min	-384S	Ø.018 [Ø.38]	9.0 oz Avg.	2.0 oz Min
-274UM	Ø.015 [Ø.38]	2.10 oz Avg.	0.5 oz Min	-281UM	Ø.015 [Ø.38]	2.10 oz Avg.	0.5 oz Min
-01S	Ø.018 [Ø.46]	9.0 oz Avg.	2.0 oz Min	-93S	Ø.018 [Ø.46]	9.0 oz Avg.	2.0 oz Min

### MOUNTING OPTIONS



**Andon Proprietary Information**  
**RoHS Compliant**

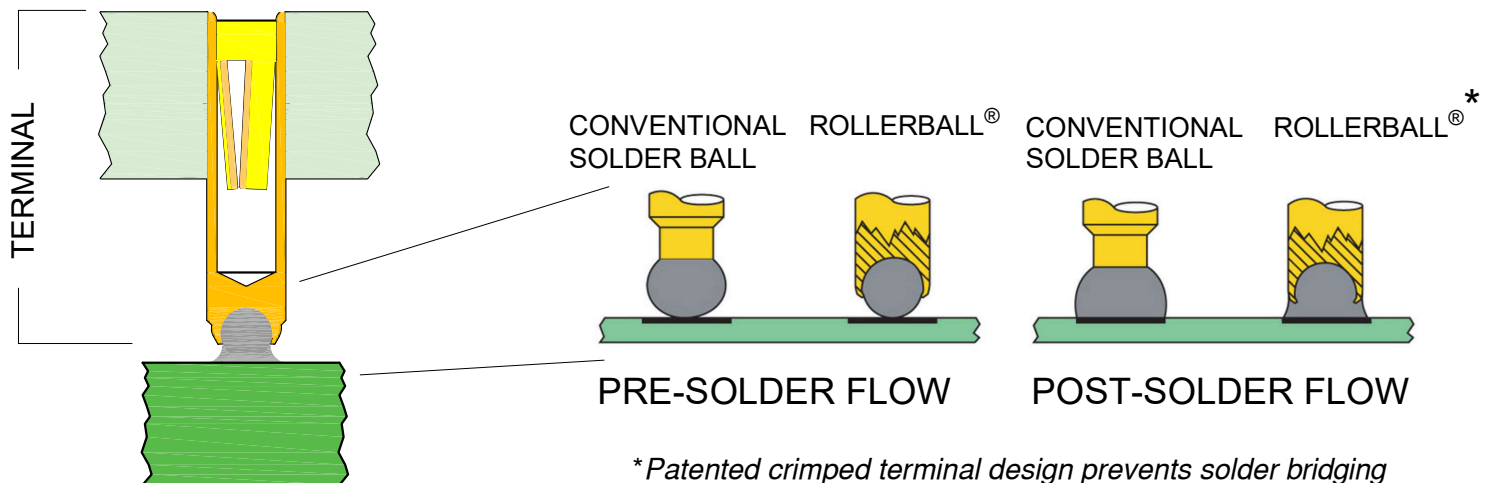
\*Sockets are not drawn to scale SST SENSING LTD. 05/14/2026



<sup>1</sup>Andon's patented Rollerball® socket terminal option provides more accurate soldering, a stronger connection, and improved electrical connectivity - especially under shock and vibration - than other solder ball terminal designs. Better yet, it can enable you to avoid expensive rework and scrap - especially with larger PCBs where coplanarity is an inherent challenge.

The bottom of these terminals has a radiused hole, to prevent gas entrapment. The terminal is crimped over the solder ball beyond its hemisphere, encapsulating it - leaving just enough of the solder ball exposed to provide sufficient solder without the solder bridging common in conventional solder ball terminal designs.

With this unique design, the critical distance between the terminal and the PC board pad is typically reduced from .036"-.040" to .018"-.022". As such, the solder becomes part of the "anchor" cross-section - providing additional mechanical strength to the connection, as well as improved electrical connectivity. Because it also provides controlled dispersion of solder, this encapsulated solder ball reduces the risk of solder bridging inherent in conventional solder ball terminal designs.



## For fast, accurate placement of SIP sockets and ultra-low profile terminals

**Phase 1:**  
Receive Carrier Assemblies designed to your pin layout.



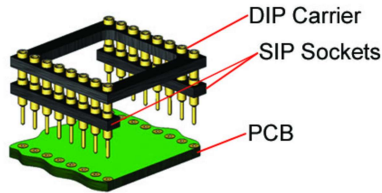
**Phase 2:**  
Place carrier assemblies onto PCB; run through your soldering process.



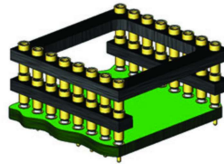
**Phase 3:**  
Remove carrier and plug in your device; discard carrier or send back to our factory for reloading.

### DIP

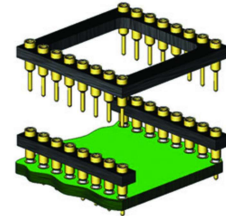
**Before Soldering**



**During Soldering**

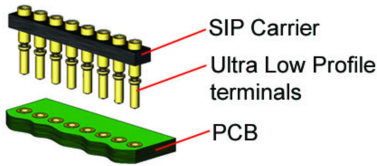


**After Soldering**

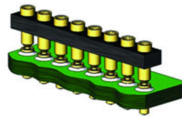


### ULTRA-LOW PROFILE SIP

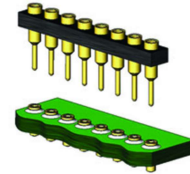
**Before Soldering**



**During Soldering**

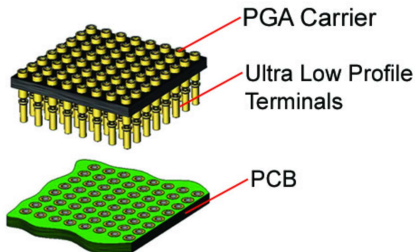


**After Soldering**

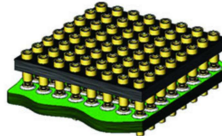


### ULTRA-LOW PROFILE PGA

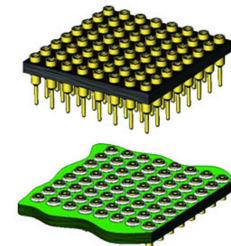
**Before Soldering**



**During Soldering**

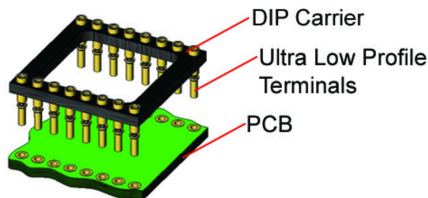


**After Soldering**

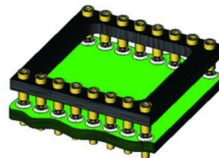


### ULTRA LOW PROFILE DIP

**Before Soldering**



**During Soldering**



**After Soldering**

